



■ Description

The JC54XXB series is a high input voltage (45V), low quiescent current (2.1uA), low-dropout linear regulator (LDO) able to provide 350mA load current. The JC54XXB family LDO offers EN pin to enable and disable the LDO output, EN pin can take 45V input voltage.

The LDO features very fast response against line voltage transient and load current transient, and ensures no overshoot voltage during the LDO start up and short circuit recovery.

The device features integrated short-circuit and thermal shutdown protection.

The device is available with fixed output voltages of 1.8V, 3.0V, 3.3V and 5.0V, and available in SOT23 and SOT89 packages.

■ Features

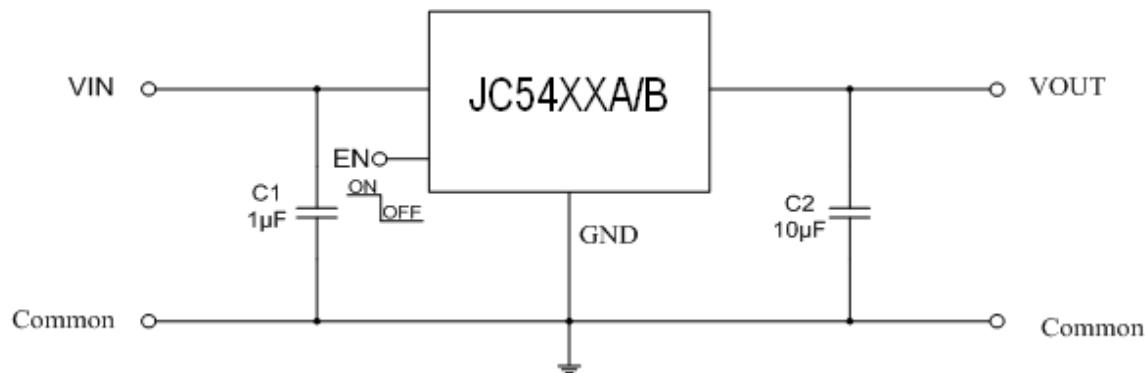
- Low Quiescent Current: 2.1uA
- High Input Voltage Rating: Up to 55V
- High Output Current: 350mA
- High PSRR: 85dB at 1Khz
- Low Dropout Voltage:
 - 35mV@10mA
 - 350mV@100mA
- Fixed Output Voltages:
 - 1.8V, 3.0V, 3.3V and 5.0V
- High-accuracy Output Voltage: A: ±1% /B: ±2%
- Fast Transient Response
- Integrated Short-Circuit Protection
- Enable pin is available
- Integrated Thermal Protection
- Available Packages:

■ Application

- Battery-powered equipment
- Smoke detector and sensor
- Micro controller Applications
- Home Appliance

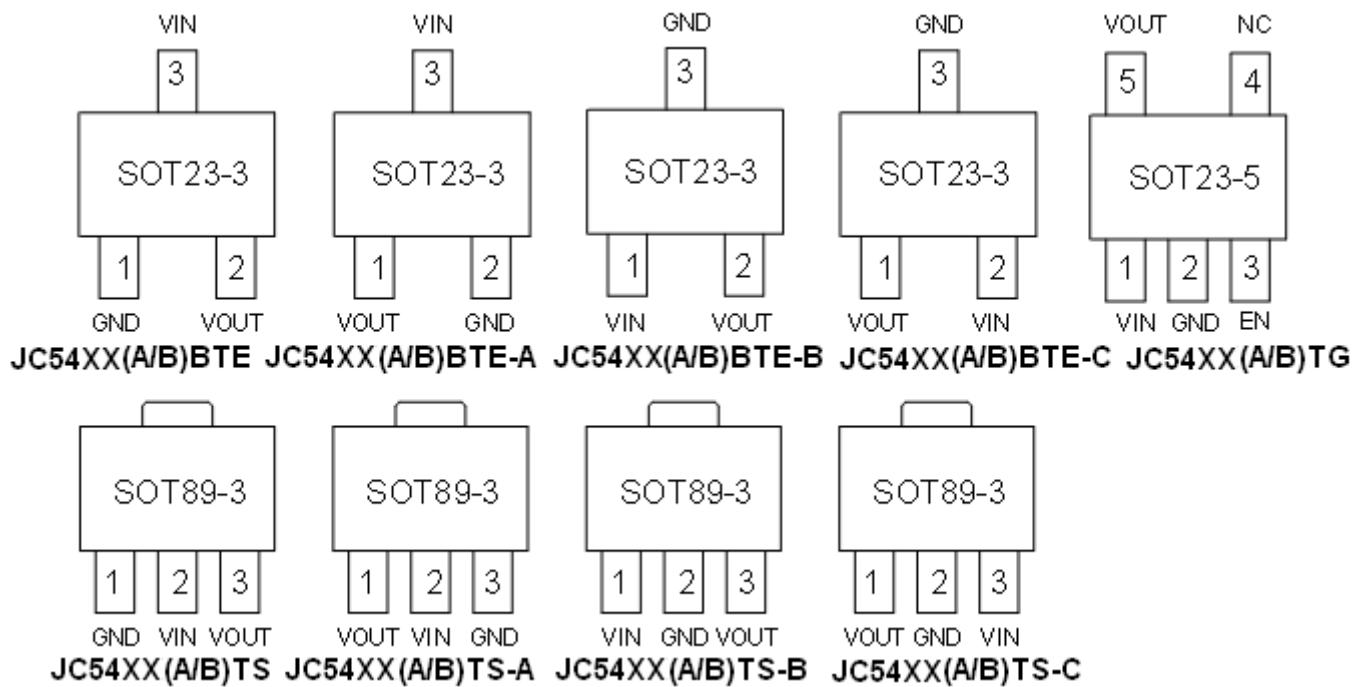
| | |
|-------------|---------|
| JC54XXBTE | SOT23-3 |
| JC54XXBTE-A | |
| JC54XXBTE-B | |
| JC54XXBTE-C | |
| JC54XXBTS | SOT89-3 |
| JC54XXBTS-A | |
| JC54XXBTS-B | |
| JC54XXBTS-C | |
| JC54XXBTG | SOT23-5 |

■ Application Circuits





■ Packages And Pin Assignment

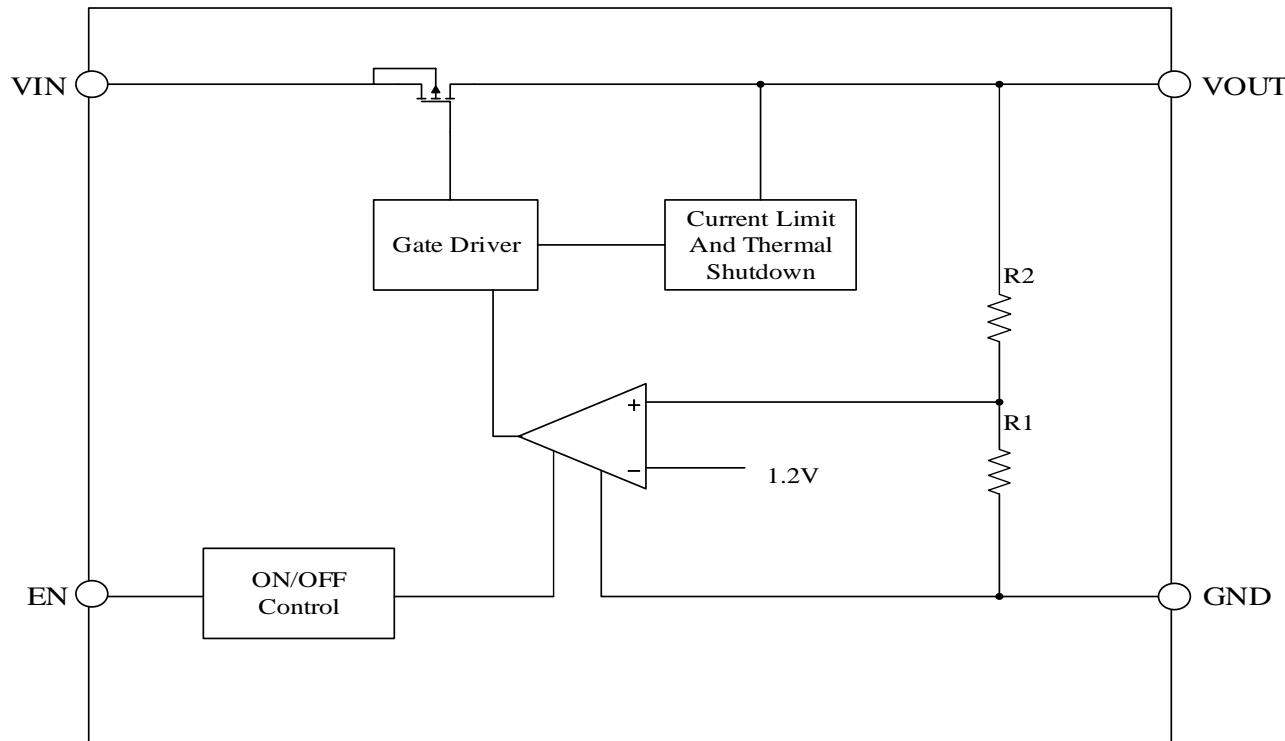


■ Pin Descriptions

| SOT23-3 | | | | PIN NAME | DESCRIPTION |
|-----------|-------------|-------------|-------------|----------|---------------|
| JC54XXBTE | JC54XXBTE-A | JC54XXBTE-B | JC54XXBTE-C | | |
| 1 | 2 | 3 | 3 | GND | Ground Pin |
| 2 | 1 | 2 | 1 | VOUT | Output Pin |
| 3 | 3 | 1 | 2 | VIN | Input Pin |
| SOT89-3 | | | | PIN NAME | DESCRIPTION |
| JC54XXBTS | JC54XXBTS-A | JC54XXBTS-B | JC54XXBTS-C | | |
| 1 | 3 | 2 | 2 | GND | Ground Pin |
| 3 | 1 | 3 | 1 | VOUT | Output Pin |
| 2 | 2 | 1 | 3 | VIN | Input Pin |
| SOT23-5 | | | | PIN NAME | DESCRIPTION |
| JC54XXBTG | | | | | |
| | 1 | | | VIN | Input Pin |
| | 2 | | | GND | Ground Pin |
| | 3 | | | EN | Enable pin |
| | 4 | | | NC | No Connection |
| | 5 | | | VOUT | Output Pin |
| | | | | | |



■ Functional Block Diagram



■ Absolute Maximum Ratings

| Item | Description | Min | Max | Unit |
|--|--|--------------------|-----|------|
| Voltage | VIN to GND | -0.3 | 55 | V |
| | VOUT to GND | -0.3 | 6 | V |
| | VOUT to VIN | -55 | 0.3 | V |
| | EN to GND | -0.3 | 55 | V |
| Current | Peak output current | Internally limited | | |
| Temperature | Operating Ambient Temperature | -40 | 85 | °C |
| | Storage Temperature | -40 | 150 | °C |
| | Operating virtual junction Temperature | - | 150 | °C |
| Thermal Resistance (Junction to Ambient) | SOT89 | 180 | | °C/W |
| | SOT23 | 360 | | °C/W |
| Power Dissipation | SOT89 | 600 | | mW |
| | SOT23 | 300 | | mW |
| Electrostatic discharge rating | Human Body Model (HBM) | 4 | | kV |
| | Charged Device Model (MM) | 100 | | V |



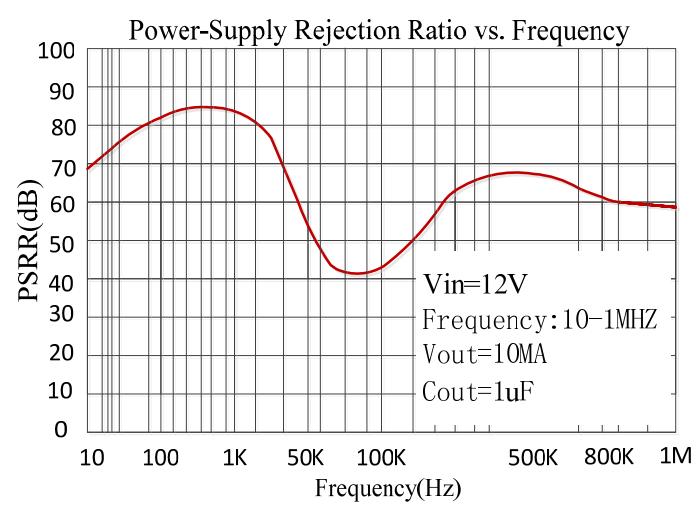
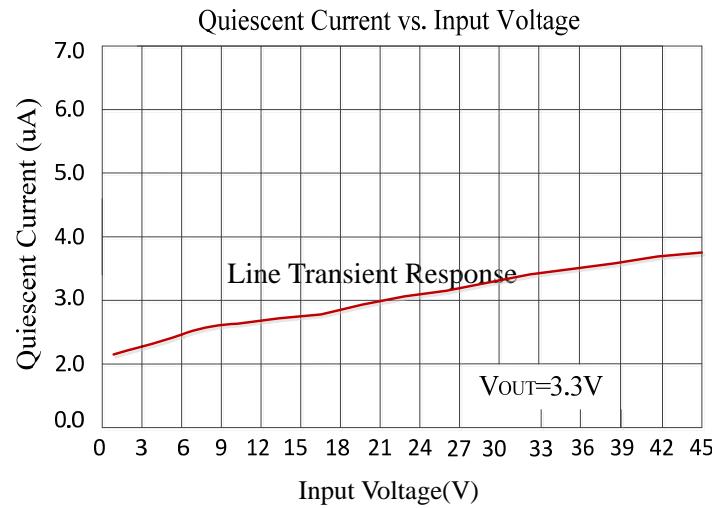
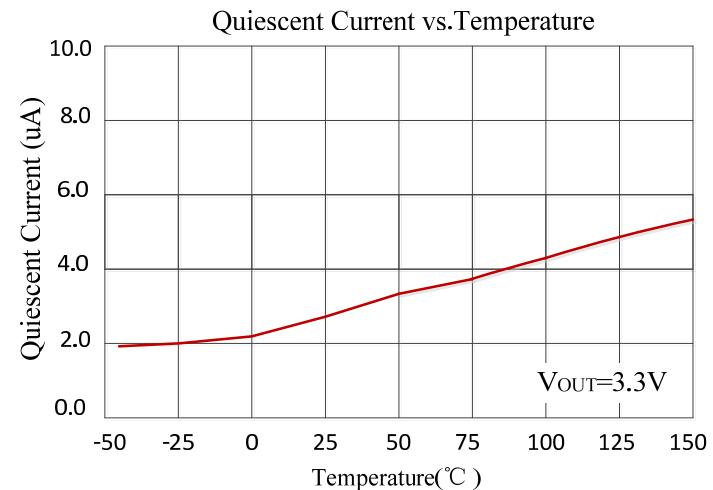
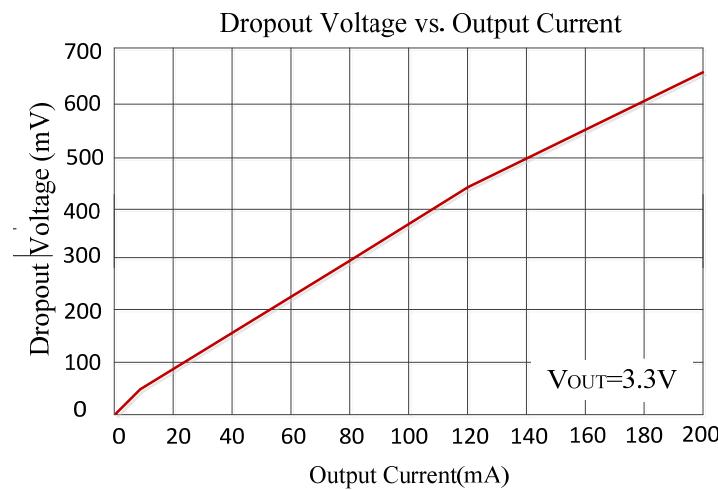
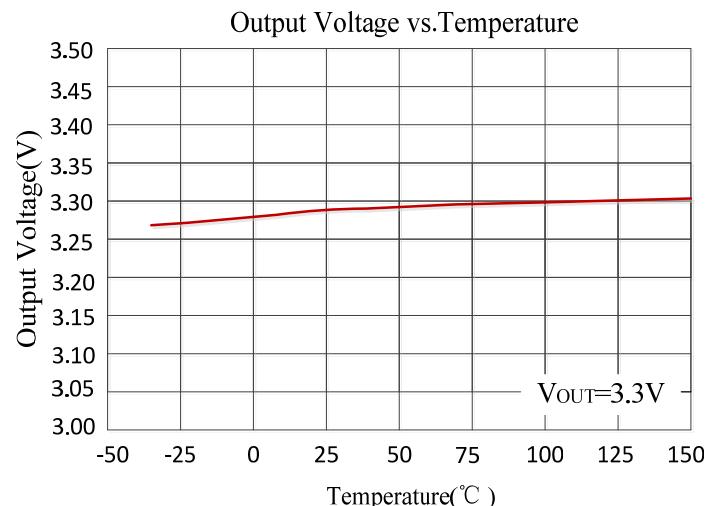
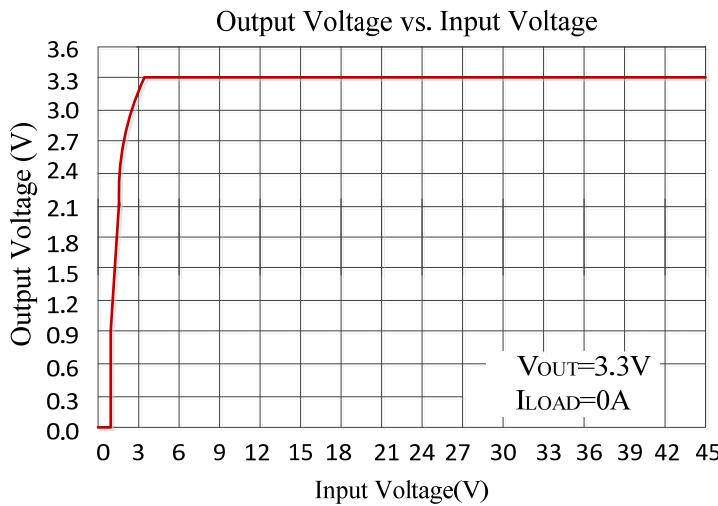
■ Electrical Characteristics

(At T_A=25°C, C_{IN}=1uF, V_{IN}=V_{OUTNOM}+1.0V, C_{OUT}=10uF, unless otherwise noted)

| Symbol | Parameter | Test Conditions | MIN | TYP | MAX | UNIT |
|--|--------------------------------|--|-------------------------------|---------------------|-------------------------------|------|
| V _{IN} | Input Voltage | | 3 | — | 45 | V |
| I _{GND} | Quiescent Current | V _{IN} =12V, No load | — | 2.1 | — | uA |
| V _{OUT} | Output Voltage | V _{IN} =12V, I _{OUT} =10mA | V _{OUTNOM} * 0.98 | V _{OUTNOM} | V _{OUTNOM} * 1.02 | V |
| I _{OUT_MAX} | Output Current | | 300 | 350 | — | mA |
| V _{DROP} | Dropout Voltage ⁽¹⁾ | I _{OUT} =10mA, V _{IN} =V _{OUTNOM} -0.1V | — | 35 | — | mV |
| | | I _{OUT} =100mA, V _{IN} =V _{OUTNOM} -0.1V | — | 350 | — | mV |
| ΔV _{OUT} (ΔI _{OUT}) | Load Regulation | V _{IN} =12V, 1mA≤I _{OUT} ≤100mA | — | 0.02 | — | %/mA |
| ΔV _{OUT} (ΔV _{IN}) | Line Regulation | I _{OUT} =1mA, V _{OUTNOM} +0.5V≤V _{IN} ≤40V | — | 0.01 | — | %/V |
| I _{LIMIT} | Current Limit | | — | 500 | — | mA |
| T _{SHDN} | Thermal Shutdown Temperature | Shutdown, temperature increasing | — | 150 | — | °C |
| | | Reset, temperature decreasing | — | 140 | — | |
| PSRR | | V _{in} =12V, I _{out} =10mA F=1Khz, V _{out} =3.3V | | 85 | | dB |
| V _{ENH} | EN High level | Enabled | 1 | — | — | V |
| V _{ENL} | EN Low level | Shutdown | — | — | 0.4 | V |

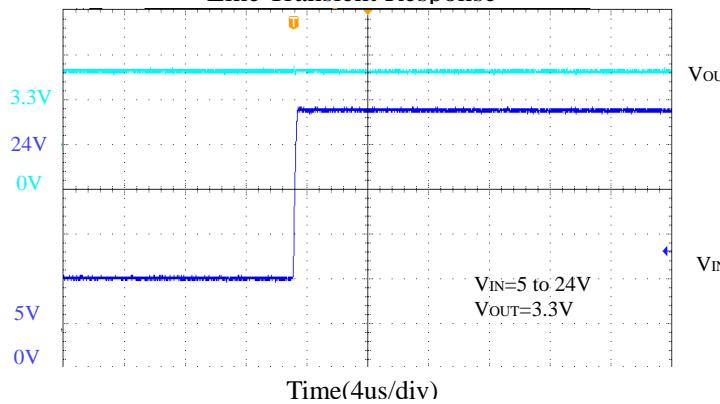
Note : (1) Dropout Voltage is the voltage difference between the input and the output at which the output voltage drops 2% below its nominal value.

■ Typical Performance Characteristics

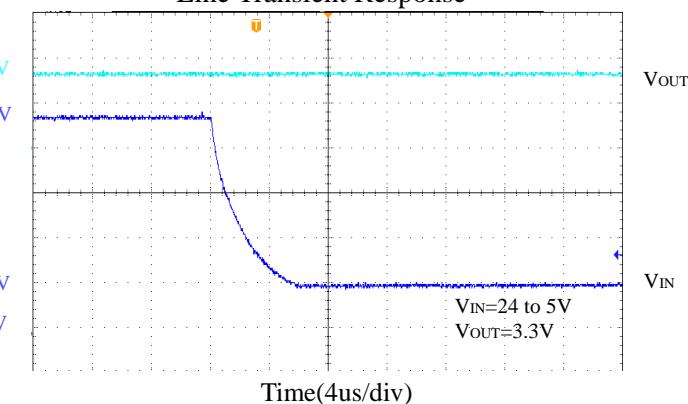
Test Condition: $T_A=25^\circ\text{C}$, $I_{\text{out}}=1\text{mA}$, $C_{\text{OUT}}=10\mu\text{F}$, unless otherwise noted



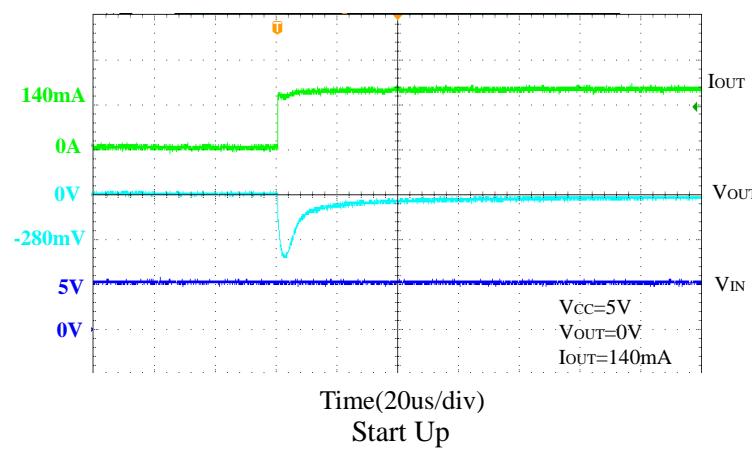
Line Transient Response



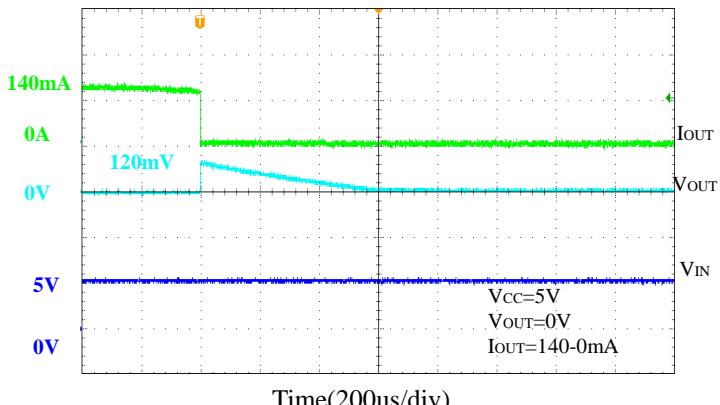
Line Transient Response



Load Transient Response

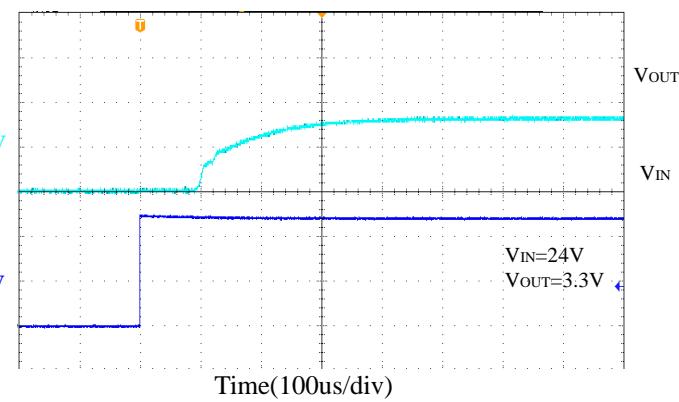


Load Transient Response



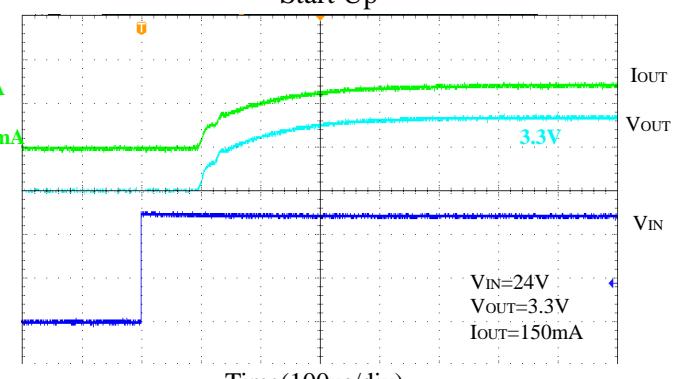
Time(20us/div)

Start Up



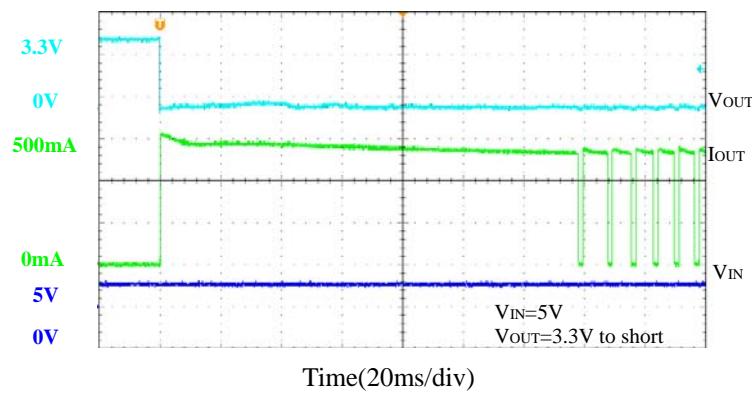
Time(100us/div)

Start Up



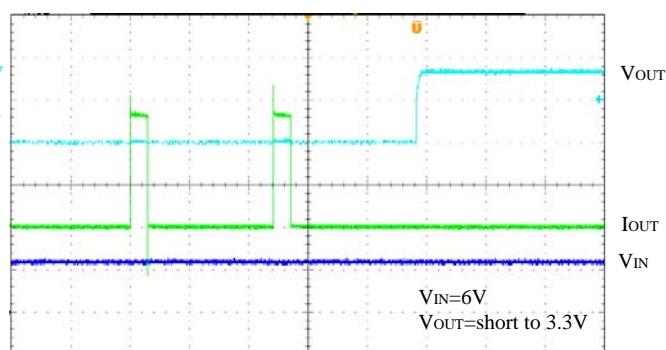
Time(100us/div)

Short Circuit Protection



Time(20ms/div)

Short Circuit Protection



Time(2ms/div)



Functional Description

Input Capacitor

A 1μF ceramic capacitor is recommended to connect between VIN and GND pins to decouple input power supply glitch and noise. The amount of the capacitance may be increased without limit. This input capacitor must be located as close as possible to the device to assure input stability and less noise. For PCB layout, a wide copper trace is required for both VIN and GND.

Output Capacitor

An output capacitor is required for the stability of the LDO. The recommended minimum output capacitance is 1μF, ceramic capacitor is recommended, and temperature characteristics are X7R or X5R. Higher capacitance values help to improve load/line transient response. The output capacitance may be increased to keep low undershoot/overshoot. Place output capacitor as close as possible to VOUT and GND pins.

EN Pin Operation

The JC54XXB is turned on by setting the EN pin to “H”. Since the EN pin is neither pulled down nor pulled up internally, do not set it in floating status. When the EN pin is not used, connect the EN pin with VIN to keep the LDO in operating mode.

Current Limit and Short Circuit Protection

When output current at VOUT pin is higher than current limit threshold or the VOUT pin is direct short to GND, the current limit protection will be triggered and clamp the output current at a pre-designed level to prevent over-current and thermal damage.

Thermal Protection

The JC54XXB has internal thermal sense and protection circuits. When excessive power dissipation happens on the device, such as short circuit at the output pin or very heavy load current with a large voltage drop across the device, the internal thermal protection circuit will be triggered, and it will shut down the power MOSFET to prevent the LDO from damage. As soon as excessive thermal condition is removed and the temperature of the device drops down, the thermal protection circuit will release the control of the power MOSFET, and the LDO device goes to normal operation.



■ Ordering And Marking Information

| Part Number | Package Outline | 5 | 4 | 3 |
|--|------------------|-----|--|---|
| JC 5433BTS-A | 1 2 3 | 1 2 | 1 2 3 | |
| Pin definition Package definition Voltage accuracy Product Name Company Name | M5433BA 1918R | | A:Pin definition B:B(±2%) A(±1%) C(±3%) 5433:5433(3.3V) 5418(1.8V) 5430(3.0V) 5450(5.0V) R:Internal Code.Variable. 1918:19-2019;18-the 18th week of this year M:M(SOT89-3) blank(SOT23) | |
| Marking | | | | |

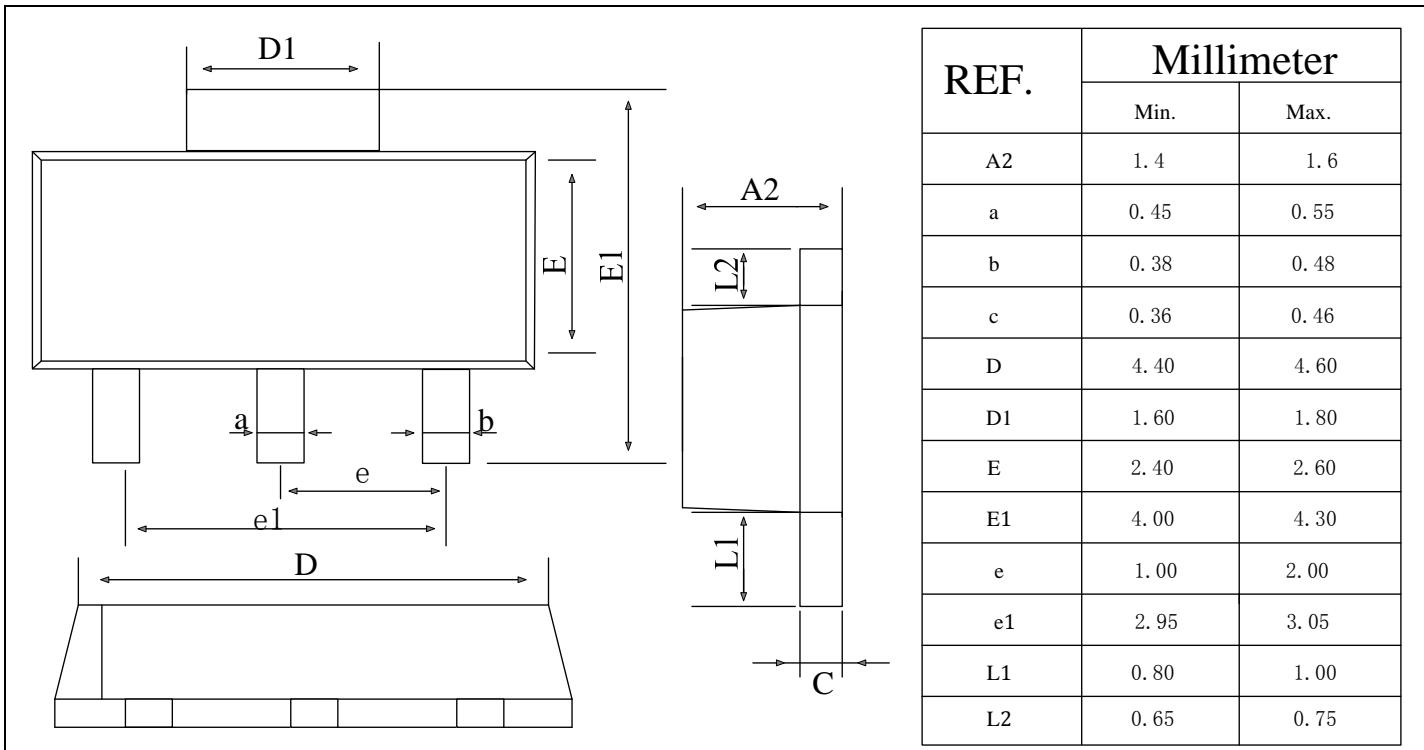
■ Package Outline Dimensions

SOT23-3

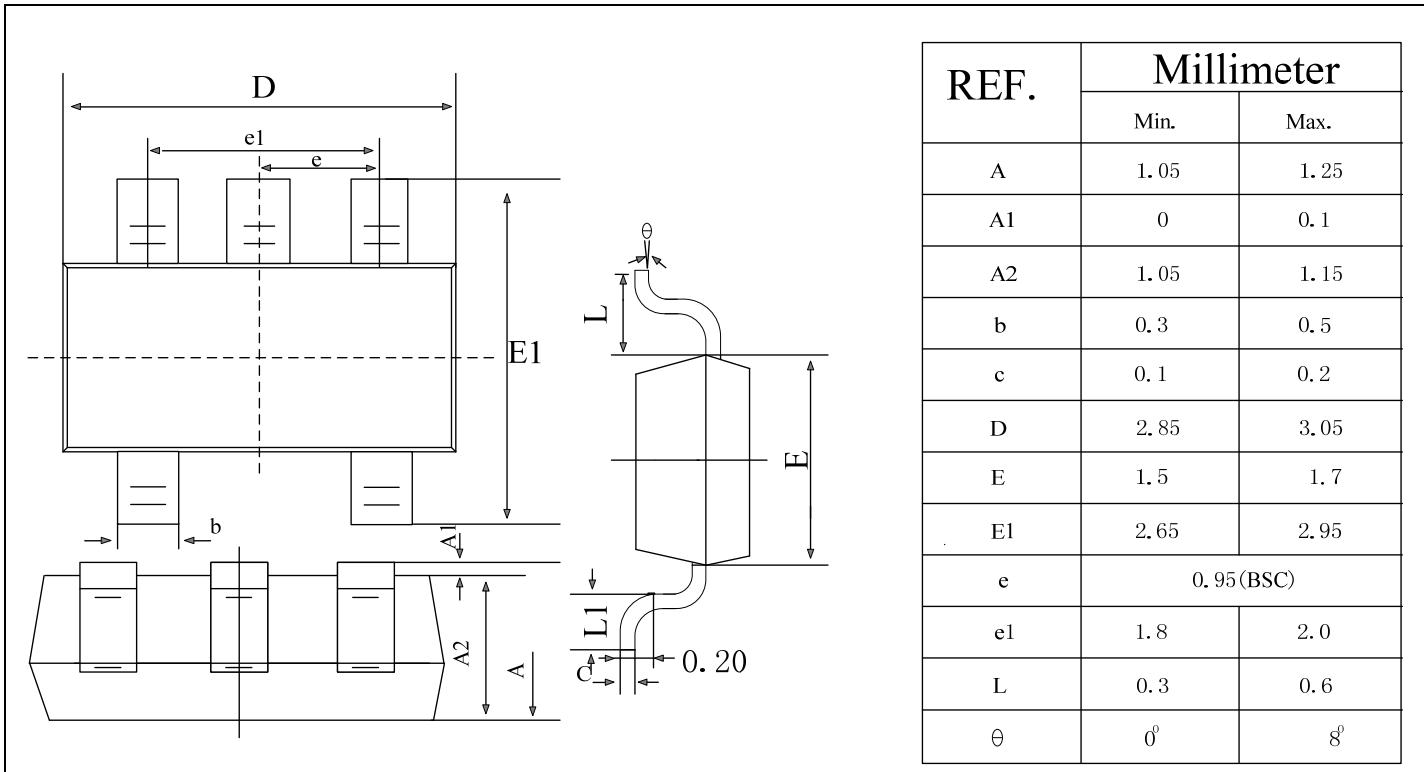
The technical drawing illustrates the physical dimensions of the SOT23-3 package. Key dimensions include:
 - Top View: A (Total width), L (Lead spacing), B (Total height), C (Lead thickness), G (Pad width), F (Pad thickness), H (Pad height), D (Pad thickness), E (Pad height).
 - Bottom View: K (Lead thickness), M (Lead pitch).
 - Side View: L (Lead thickness), M (Lead pitch).

| REF. | Millimeter | |
|------|------------|------|
| | Min. | Max. |
| A | 2.82 | 2.92 |
| B | 2.65 | 2.95 |
| C | 1.56 | 1.60 |
| D | 0.35 | 0.55 |
| E | 0 | 0.1 |
| F | 0.45 | 0.55 |
| G | 1.90 | REF. |
| H | 1.0 | 1.3 |
| K | 0.10 | 0.20 |
| J | 0.40 | — |
| L | 0.85 | 1.15 |
| M | 0° | 10° |

SOT89-3

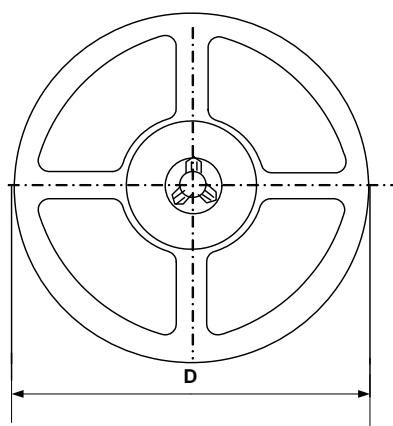
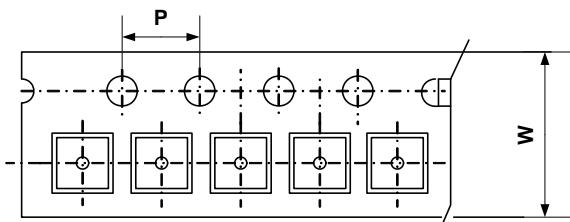


SOT23-5





■ Packing Information



| Type | W(mm) | P(mm) | D(mm) | Qty (pcs) |
|---------|-------------|------------|----------|-----------|
| SOT23-3 | 8.0±0.1 mm | 4.0±0.1 mm | 180±1 mm | 3000pcs |
| SOT23-5 | 8.0±0.1 mm | 4.0±0.1 mm | 180±1 mm | 3000pcs |
| SOT89-3 | 12.0±0.1 mm | 4.0±0.1 mm | 180±1 mm | 1000pcs |